FR1A THRU FR1M

SURFACE MOUNT FAST RECOVERY RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 1.0 AMPERE

FEATURES

· Plastic package has Underwriters Laboratory

Flammability Classification 94V-O

- · For surface mounted applications
- · Low profile package
- · Easy pick and place
- · Built-in strain relief
- · Fast Recovery times for high efficiency
- \cdot High temperature soldering : 250°C /10 seconds at terminals

MECHANICAL DATA

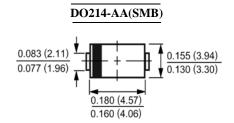
Case: Molded plastic, DO-214AA(SMB)

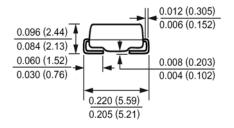
Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 12mm tape per EIA STD RS-481

Weight: 0.003 ounce, 0.093 gram





Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at $25\,^{\circ}$ C ambient temperature unless otherwise specified.

Single phase, half wave, 60H_Z, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	FR1A	FR1B	FR1D	FR1G	FR1J	FR1K	FR1M	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T_L =90 $^{\circ}$ C	I _(AV)	1.0							Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM} 30							Amp	
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 1.0A	V_{F}	1.3							Volts
Maximum Reverse Current at T _A =25℃	ī	5.0							μАтр
at Rated DC Blocking Voltage $T_A=125$ °C	IR.	I _R 150							μεмир
Typical Junction Capacitance (Note 1)	C_{J}	10							pF
Typical Thermal Resistance (Note 2)	$\mathbf{R}_{ heta \mathrm{JL}}$	32							°C/W
Maximum Reverse Recovery Time (Note 3)	T_{RR}		1	50		250	5	00	nS
Operating Junction Temperature Range	T_{J}	-55 to +150							ဗ
Storage Temperature Range	Tstg	-55 to +150							ဗ

NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas
- 3- Reverse Recovery Test Conditions: I_F =.5A, I_R =1A, I_{RR} =.25A.



RATINGS AND CHARACTERISTIC CURVES

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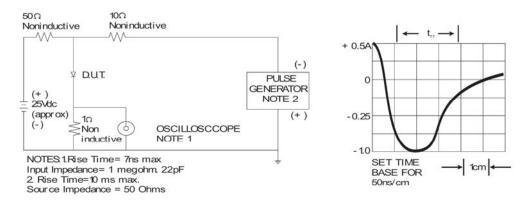


Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

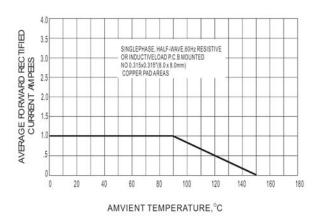


Fig. 2-MAXIMU AVERAGE FORWARD CURRENT RATING

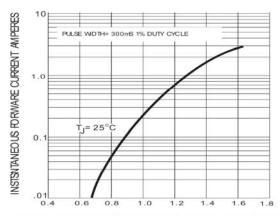


FIG. 3- TYPICAL INSTANTANEOUS
FORWARD CHARACTERISTICS

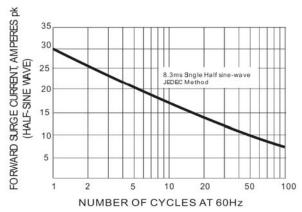


Fig.4-MAXIMUM NON-REPEITIVE SURGE CURRENT

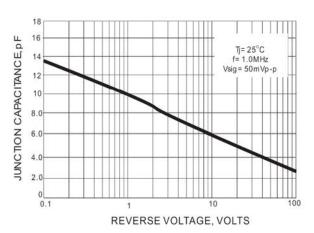


Fig.5-TYPICAL JUNCTION CAPACITANCE